# CMP1405A/CMB1405A



### N-Channel Enhancement Mode Field Effect Transistor

## **General Description**

The 1405A is a N-channel Power MOSFET. It has specifically been designed to minimize input capacitance and gate charge. The device is therefore suitable in advanced high-efficiency switching applications.

### Features

- Advanced Process Technology
- Ultra Low On-Resistance
- Dynamic dv/dt Rating
- 175°C Operating Temperature
- Fast Switching
- Fully Avalanche Rated
- Lead-Free

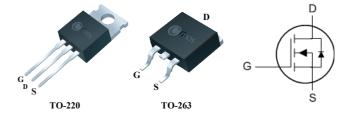
## **Product Summary**

BVDSS	RDSON	ID
68V	5.5mΩ	120A

## Applications

- LED power controller
- DC-DC & DC-AC converters
- High current, High speed switching
- Solenoid and relay drivers
- Motor control, Audio amplifiers

## TO-220/263 Pin Configuration



Туре	Package	Marking		
CMP1405A	TO-220	CMP1405A		
CMB1405A	TO-263	CMB1405A		

### Absolute Maximum Ratings

Symbol	Parameter	Rating	Units	
V <sub>DS</sub>	Drain-Source Voltage	68	V	
V <sub>GS</sub>	Gate-Source Voltage	±20	V	
I <sub>D</sub> @T <sub>C</sub> =25°C	Continuous Drain Current,VGS @ 10V	120	A	
I <sub>D</sub> @T <sub>C</sub> =100°C	Continuous Drain Current,VGS @ 10V	96	A	
I <sub>DM</sub>	Pulsed Drain Current	360	A	
EAS	Single Pulse Avalanche Energy	800	mJ	
P <sub>D</sub> @T <sub>C</sub> =25°C	Power Dissipation	250	W	
T <sub>STG</sub>	Storage Temperature Range -55 to 175		°C	
TJ	Operating Junction Temperature Range	-55 to 175	°C	

## **Thermal Data**

Symbol	Parameter	Тур.	Max.	Unit	
R <sub>θJA</sub>	Junction-to-Ambient (PCB mount) <sup>3</sup>		62	°C/W	
R <sub>θJC</sub>	Junction-to-Case		0.5	°C/W	



#### **N-Channel Enhancement Mode Field Effect Transistor**

#### Electrical Characteristics (T<sub>J</sub>=25 °C, unless otherwise noted)

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
BV <sub>DSS</sub>	Drain-Source Breakdown Voltage	$V_{GS}$ =0V , $I_{D}$ =250uA	68			V
R <sub>DS(ON)</sub>	Static Drain-Source On-Resistance	V <sub>GS</sub> =10V , I <sub>D</sub> =30A			5.5	mΩ
V <sub>GS(th)</sub>	Gate Threshold Voltage	$V_{GS}=V_{DS}$ , $I_{D}=250$ uA	2		4	V
I <sub>DSS</sub>	Drain-Source Leakage Current	V <sub>DS</sub> =60 V, V <sub>GS</sub> =0V			1	uA
I <sub>GSS</sub>	Gate-Source Leakage Current	$V_{GS}$ =±20V , $V_{DS}$ =0V			±100	nA
gfs	Forward Transconductance	V <sub>DS</sub> =10V , I <sub>D</sub> =10A		25		S
R <sub>g</sub>	Gate Resistance	$V_{DS}$ =0V , $V_{GS}$ =0V , f=1MHz		2.5		Ω
Qg	Total Gate Charge	I <sub>D</sub> =80A		115		
Q <sub>gs</sub>	Gate-Source Charge	V <sub>DD</sub> =44V		25		nC
Q <sub>gd</sub>	Gate-Drain Charge	V <sub>GS</sub> =10V		50		
T <sub>d(on)</sub>	Turn-On Delay Time	V <sub>DD</sub> =30V		25		
Tr	Rise Time	I <sub>D</sub> =80A		24		
T <sub>d(off)</sub>	Turn-Off Delay Time	R <sub>G</sub> =2.4Ω		50		ns
T <sub>f</sub>	Fall Time	V <sub>GS</sub> =10V		23		
C <sub>iss</sub>	Input Capacitance			6500		
C <sub>oss</sub>	Output Capacitance	$V_{DS}$ =25V , $V_{GS}$ =0V , f=1MHz		1100		pF
C <sub>rss</sub>	Reverse Transfer Capacitance			280		

## **Diode Characteristics**

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
ls	Continuous Source Current	$-V_G=V_D=0V$ , Force Current			120	А
I <sub>SM</sub>	Pulsed Source Current <sup>1</sup>				360	А
V <sub>SD</sub>	Diode Forward Voltage	V <sub>GS</sub> =0V , I <sub>S</sub> =45A , T <sub>J</sub> =25℃			1.2	V

Note :

1. The test condition is  $V_{\rm DS}{=}30V$  ,  $V_{\rm GS}{=}10V$  ,  $L{=}1mH$  ,  $I_{\rm D}$  =40A.

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